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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Scott D. Maurer
Title: ARCHITECTURAL MOLDING
Serial No.: 09/337,243
Filed: June 22, 1999
Docket: 30349

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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.97 and 1.98, Applicant is submitting herewith Form PTO-1449 listing references for consideration by the Examiner. Also submitted herewith is a legible copy of each reference. The undersigned hereby certifies that each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

Respectfully submitted,
PEARNE & GORDON LLP

By John P. Murtaugh
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Date: 9-28-00

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on the date indicated below.

John P. Murtaugh
Name of Attorney for Applicant(s)
9-28-00 John P. Murtaugh
Date Signature of Attorney